



Data Sheet

Customer: _____

Part No: CL-SP1615GRB-02(6PIN) _____

Sample No: _____

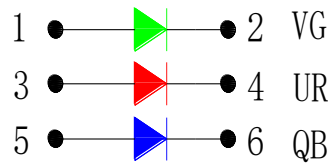
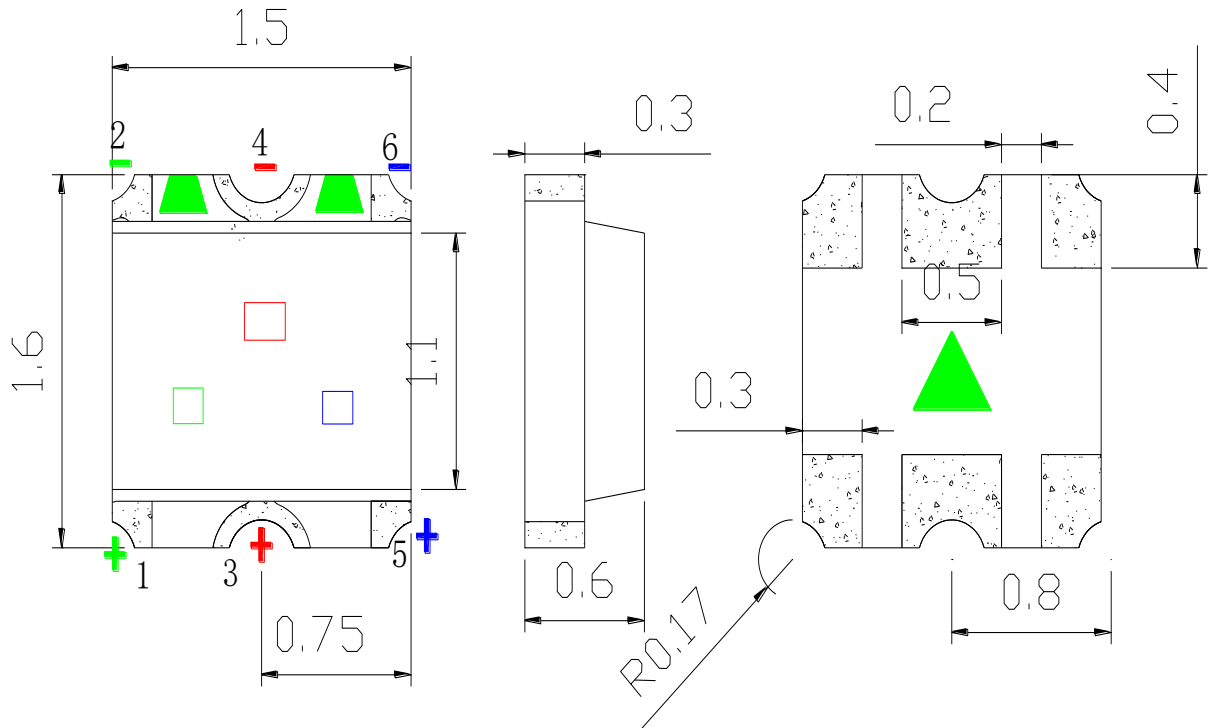
Description: _____

Item No: _____

| Customer | | | |
|----------|------------|----------|------|
| Check | Inspection | Approval | Date |
| | | | |

1. Dimensions

(Units): (mm)



DB1615A01

All dimensions area in mm tolerance is $\pm 0.05\text{mm}$ unless otherwise noted. tes:

2. Electrical / Optical characteristics

(1) Absolute Maximum Ratings (TA=25°C)

| tem | Symbol | Absolute Maximum Rating | | | Unit |
|-----------------------|--------|-------------------------|-------|-----|------------|
| | | Blue | Green | Red | |
| Forward Current | IF | 25 | 25 | 25 | mA |
| Pulse Forward Current | IFP | 90 | 90 | 60 | mA |
| Reverse Voltage | VR | 5 | | | V |
| Power Dissipation | PD | 135 | | | mW |
| Operating Temperature | Topr | -40°C To +85°C | | | ° C |
| Storage Temperature | Topr | -40°C To +85°C | | | ° C |
| Soldering Temperature | Tsltd | Reflow Soldering:240°C | | | for 10sec. |
| | | Hand Soldering :350°C | | | for 3sec |

IFP Conditions : 1/10 Duty Cycle, 0.1 msec Pulse Width

(2) Initial Electrical/Optical Characteristics (TA=25°C)

| Symbol | Item | Units | Device | Min | Typ. | Max. | Test Conditions |
|----------------------|---------------------|-------|--------|-----|------|------|-----------------|
| VF | Forward Voltage | V | Blue | 2.8 | 3.0 | 3.3 | IF=20mA |
| | | | Green | 2.8 | 3.0 | 3.3 | IF=20mA |
| | | | Red | 1.8 | 1.9 | 2.2 | IF=20mA |
| IR | Reverse Current | uA | - | - | - | 2 | VR=7V |
| $\Delta \lambda 1/2$ | Viewing Angle | ° | - | - | 120 | - | IF=5mA |
| C | Capacitance | PF | Blue | - | 100 | - | VF=0V f=1MHz |
| | | | Green | - | 40 | - | |
| | | | Red | - | 25 | - | |
| Iv | Luminous Intensity | Mcd | Blue | 100 | 150 | 200 | IF=20mA |
| | | | Green | 500 | 650 | 800 | IF=20mA |
| | | | Red | 100 | 150 | 200 | IF=20mA |
| λD | Doninant Wavelength | Nm | Blue | 466 | 469 | 474 | IF=20mA |

| | | | | | | |
|--|--------------------|-------|-----|-----|-----|---------|
| | DominateWavelength | Green | 518 | 522 | 526 | IF=20mA |
| | | Red | 618 | 620 | 625 | IF=20mA |

Tolerance of measurement of Vf is ± 0.05 V..
Luminous Intensity Measurement allowance is $\pm 10\%$.

| Item | EmittingColor | Symbol | TestConditions | Min. | Max. | Units |
|--------------------|---------------|--------|----------------|------|------|-------|
| Luminous Intensity | R | Iv | IF=20mA | 100 | 200 | Mcd |
| | G | Iv | IF=20mA | 500 | 800 | Mcd |
| | B | Iv | IF=20mA | 100 | 200 | Mcd |

Color Coordinates Measurement allowance is ± 1 nm.

(3)Luminous Intensity Ranking (TA=25°C)

Luminous Intensity Measurement allowance is $\pm 10\%$.

Above are the reference for minimum and maximum of luminous intensity which rank in the rate of 1:1.35 in the process of light splitting when manufacturing massively

(4) Color Coordinates Ranking (TA=25°C)

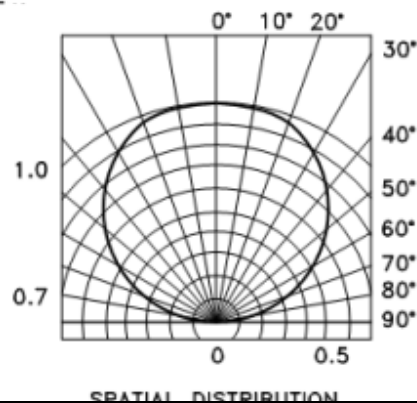
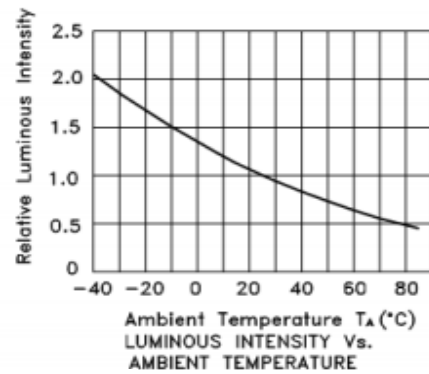
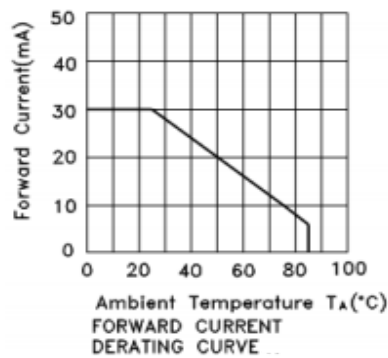
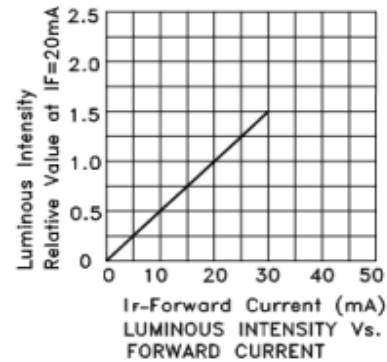
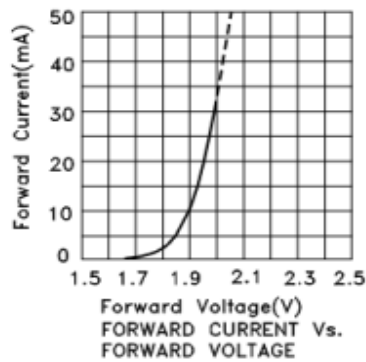
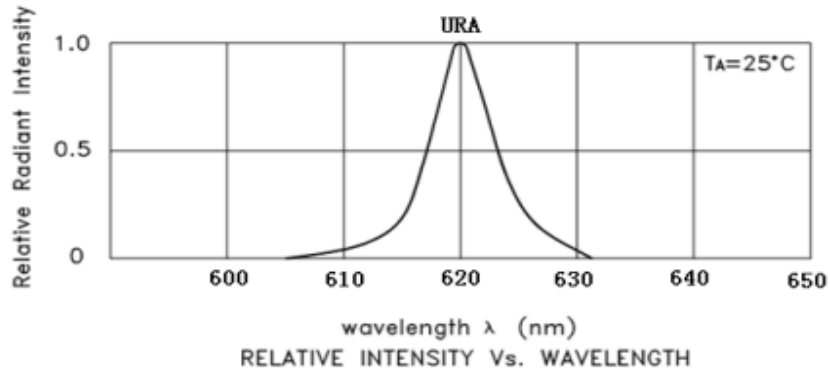
| Item | EmittingColor | Symbol | Test Conditions | Min. | Max. | Units |
|---------------------|---------------|-------------|-----------------|------|------|-------|
| Dominate Wavelength | R | λD | IF=20mA | 618 | 625 | nm |
| | G | λD | IF=20mA | 518 | 526 | nm |
| | B | λD | IF=20mA | 466 | 474 | nm |

Color Coordinates Measurement allowance is ± 0.5 nm.

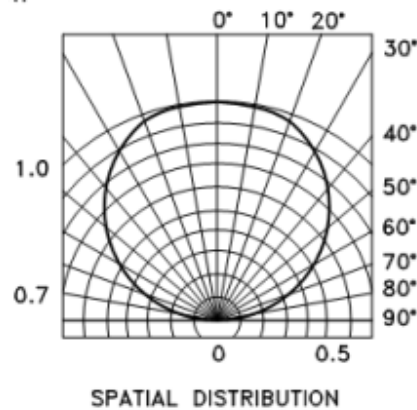
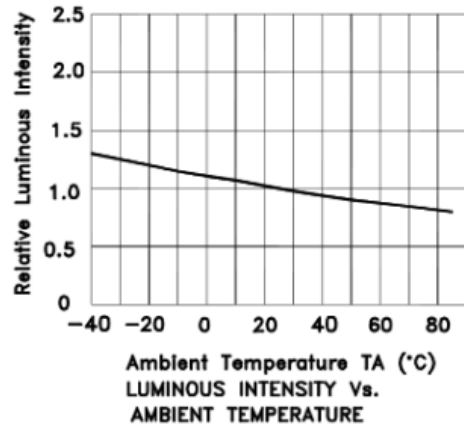
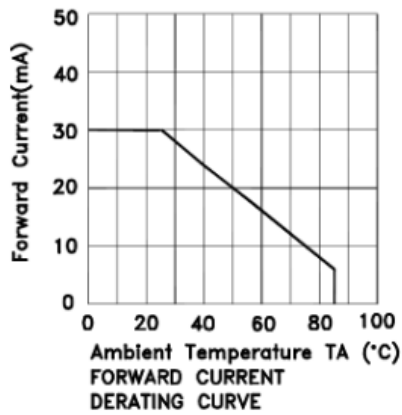
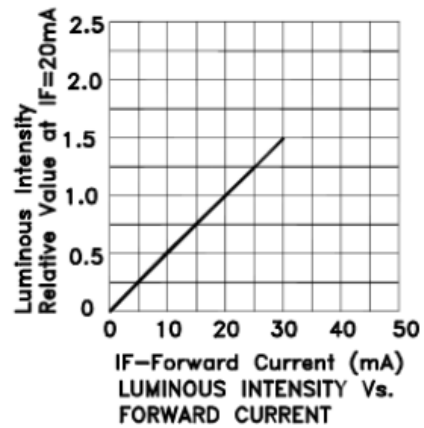
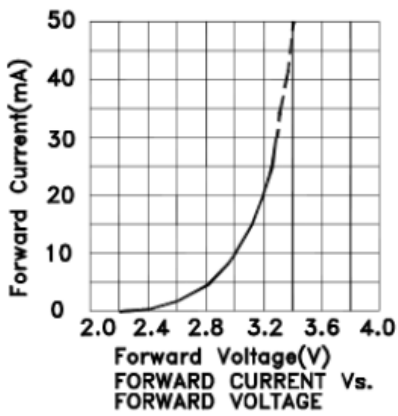
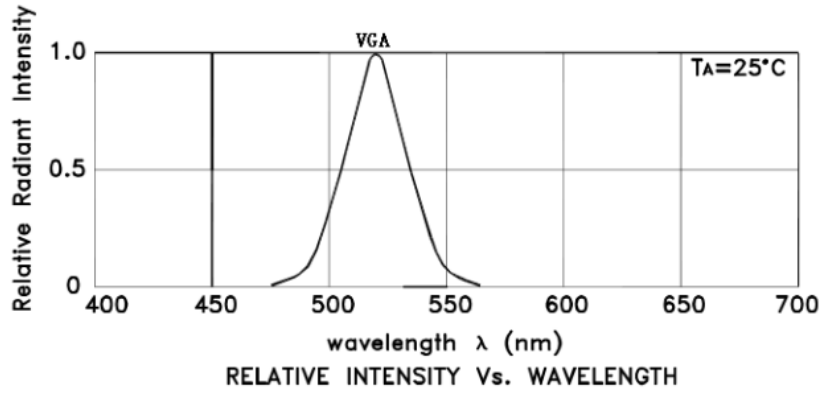
Above are the reference for minimum and maximum of wavelength, while it ranks as:R:5nm/G:2.5nm/B:2.5nm, when light splitting in mass manufacturing.

3. Characteristic curve

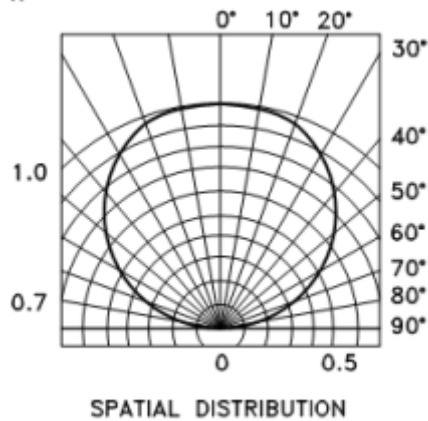
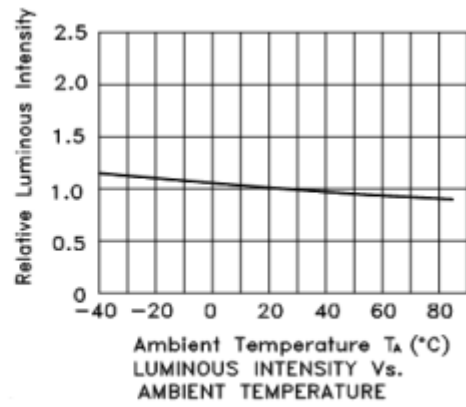
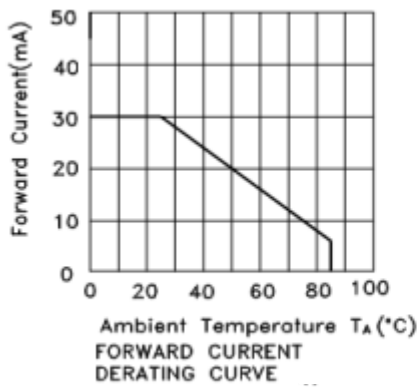
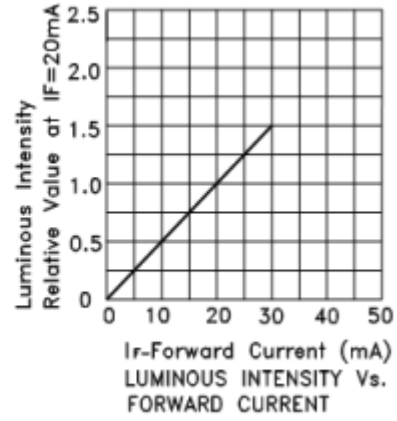
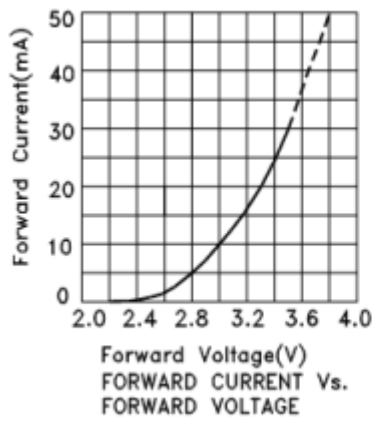
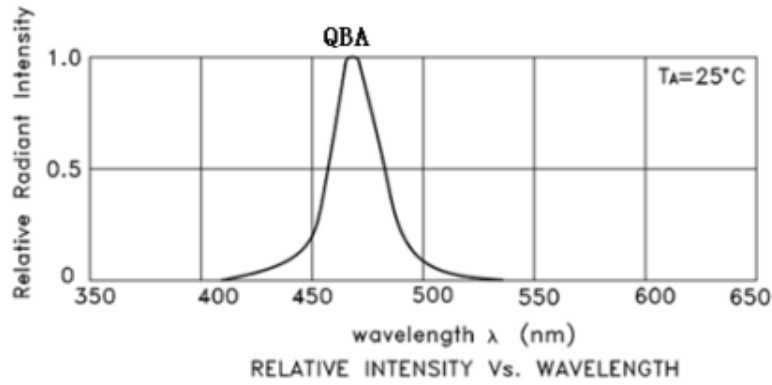
Red



Green



Blue



RELIABILITY

(1) Test Items and Results

| NO. | Test Item | Reference Standard | Test Conditions | (Hours/Cycles) | Sample | Number of Damaged |
|-----|---|--------------------------|--|----------------|--------|-------------------|
| 1 | Temperature Cycle | JEITA ED-4701 | -40 °C - 25 °C - 100 °C - 25 °C 30min 5min 30min 5min | 100 Cycles | 50 | 0/20 |
| 2 | Thermal shock | MIL-STD-202G | -40°C ~ 100°C 15min 15min | 500 Cycles | 50 | 0/20 |
| 3 | High Temperature Storage | JEITA ED-4701 200 201 | Ta=100°C | 1000 Hours | 50 | 0/20 |
| 4 | Low Temperature Storage | JEITA ED-4701 200 201 | Ta=-40°C | 1000 Hours | 50 | 0/20 |
| 5 | Room Temperature Life Test | | Ta=25±5°C IF=20mA | 1000 Hours | 50 | 0/20 |
| 6 | High Temperature High Humidity Life Test | | Ta=60°C RH=85% IF=20mA | 1000 Hours | 50 | 0/20 |
| 7 | Solderability (Reflow Soldering) | JEITA ED-4701 300 303 | Tsol=235°C ± 5°C, 5sec (Using Flux, Lead Solder) | 1 time, 5sec | 10 | 0/10 |
| 8 | Resistance to Soldering Heat (Reflow Soldering) | JEITA ED-4701 300 301 | Tsol=260°C, 10 sec Pre Treatment: 35 °C 95% RH96 Hrs | 2 time, 10sec | 10 | 0/10 |

The above test items such as differences or special customer specific requirements according to the actual situation in accordance with the requirements of customers to try the requirements with the customer, the customer is not required by our test standard test. Different products using different current test

(1) Soldering Conditions

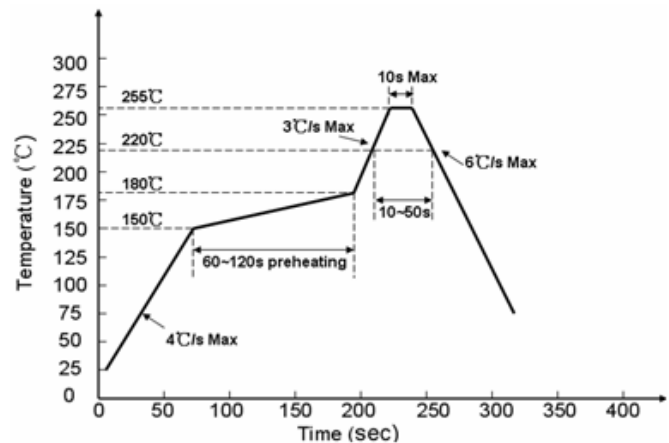
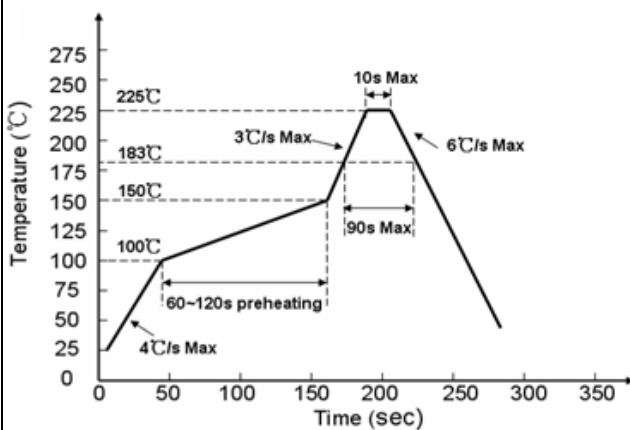
Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and Second soldering process.

(Recommended soldering conditions)

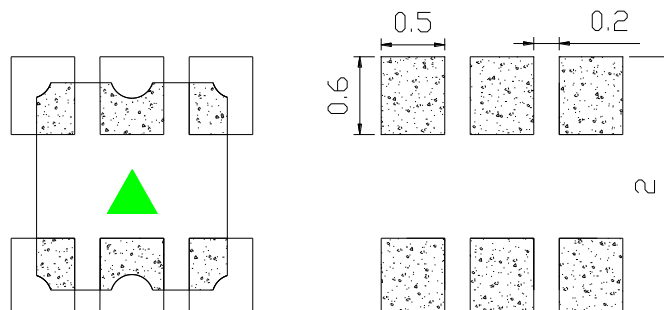
| Reflow soldering | | | Hand welding | |
|------------------|---------------|------------------|----------------|-------------------------------|
| | Lead Solder | Lead-free Solder | Temperature | 350° C Max. |
| Pre-heat | 140 ~ 160° C | 180 ~ 200° C | Soldering time | 3 sec. Max. (onetime only) |
| Pre-heat time | 120 sec. Max. | 120 sec. Max. | | |
| Peak temperature | 230° C Max. | 250° C Max. | | |
| Soldering time | 10 sec. Max. | 10 sec. Max. | | |
| Condition | 参考下图 | 参考下图 | | |

(Lead Solder)

(Lead-Free Solder)



(Recommended Soldering Pattern) (Units:mm)



(2) Static Electricity

It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

All devices, equipment and machinery must be properly grounded.

Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs do not light at the low current. Criteria : (VF > 2.0V at IF=0.5mA)

(3) Moisture Proof Package

It is recommended that moisture proof package be used .

(4) Storage

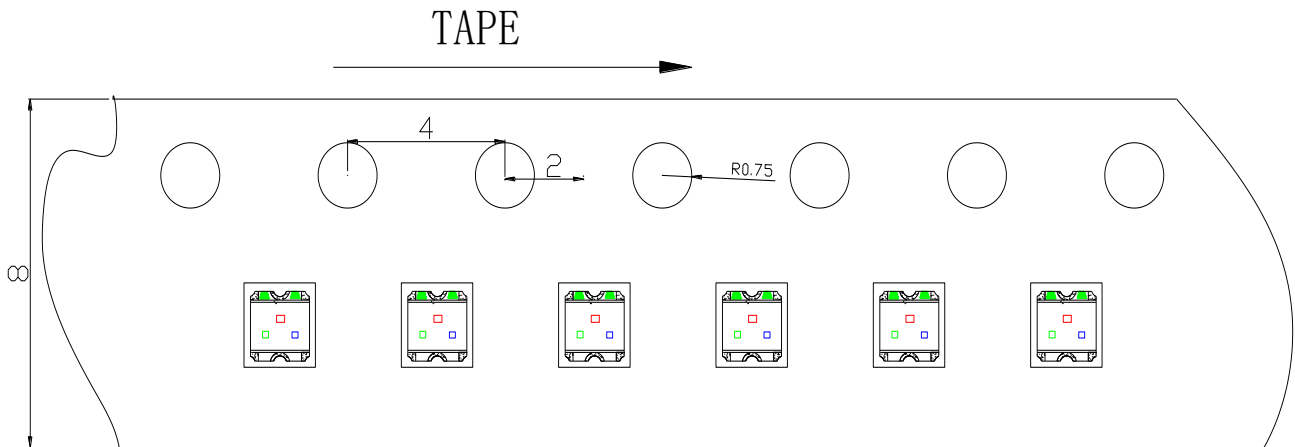
Before opening the package ,The LEDs should be kept at 30° C or less and 70%RH or less. The LEDs should be used within a year.

(5) After opening the package, The LEDs should be soldered within 24 hours (1days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages , such as sealed containers with packages of moisture absorbent material (silica gel).

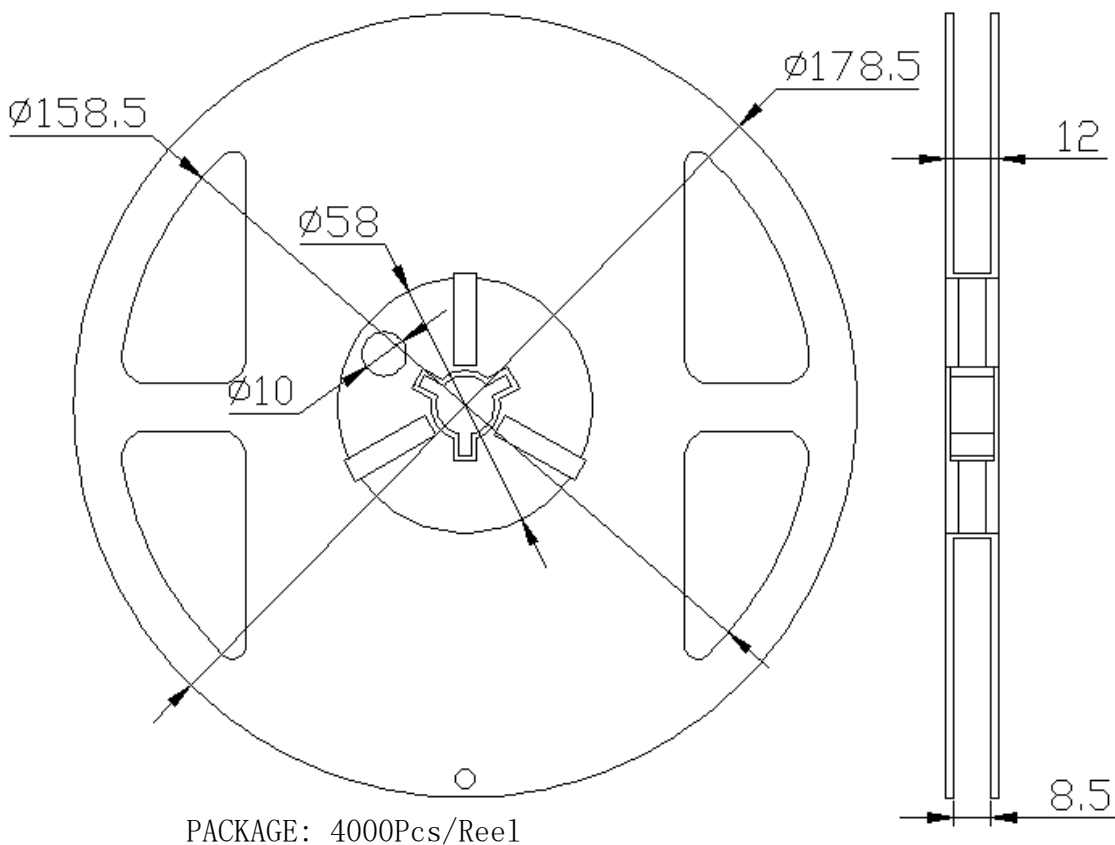
If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions Baking treatment : more than 12 hours at $60 \pm 5^{\circ}$ C.

6. PACKAGING

- (1) The LEDs are packed in cardboard boxes after taping.
- (2) Taping Specifications (Units:mm)
- (3) Manner of packing



- (4) Reel Dimensions

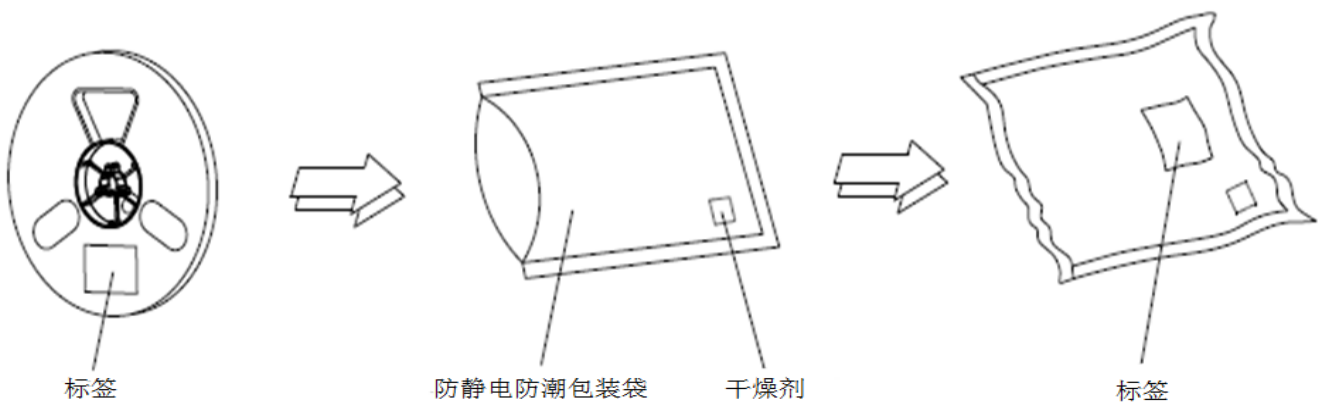


(5) The label on the minimum packing unit shows ; Part Number, Lot Number, Ranking, Quantity.

(6) Keep away from water, moisture in order to protect the LEDs.

(7) The LEDs may be damaged if the boxes are dropped or receive a strong impact against them. so precautions must be taken to prevent any damage.

7. Moisture Resistant Packaging



Note: The tolerances unless mentioned is $\pm 0.1\text{mm}$, Unit: mm

Surface mount LED is packed in reels, LED is packed in plain or antistatic bags and then packed in cartons. Cartons are used to protect the LED from mechanical shocks during shipping. Cartons are not waterproof, so please be waterproof